U.S. Department of Commerce FORM PTO-1595 09-01-2005 Patent and Trademark Office 1-31-92 Attorney Docket No. 04329.3615 Attorney Customer Number: 22,852 ATTN. BOX ASSIGNMENTS RECORDATION To the Honorable Commissioner of 103072666 **SERVICES** Please record the attached original 2. Name and address of receiving party(ies): 1. -Name of conveying party(ies): 1) Kunihiro MIYAZAKI 1) KABUSHIKI KAISHA TOSHIBA Names: 2) Hirovuki MATSUO 3) Toshiki NAKAJIMA 2) SEIKO EPSON CORPORATION Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No Internal Address: Street Addresses: 3. 1) 1-1 Shibaura 1-chome, Minato-Nature of conveyance: ku, Tokyo 105-8001, Japan 2) 4-1, Nishishinjuku 2-chome, Shinjuku-ku, Tokyo, Japan  $\boxtimes$ City: Assignment Merger Change of Name Zip Code: Security State: Agreement Other: Additional name(s) & Address(es) attached? **Execution Date:** 1) August 9, 2005 ☐ Yes ⊠ No 2) August 11, 2005 3) August 11, 2005 Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application: 1) August 9, 2005 2) August 11, 2005 3) August 11, 2005 Patent Application Number(s): B. Patent Number(s): A. Additional numbers attached? ☐ Yes ⊠ No 4. Name and address of party to whom correspondence 5. Total number of applications and registrations concerning document should be mailed: involved: 1 Mr. Ernest F. Chapman 6. Name: Total fee (37 CFR 3.41): \$40 08/30/2005 FFANAIA2 00000033 11211708  $\boxtimes$ Enclosed (Please charge deficiency to deposit account) 01 FC:8021 40.00 DP Authorized to be charged to deposit account FINNEGAN, HENDERSON, FARABOW, GARRETT Internal Address: & DUNNER, L.L.P. Street Address: 901 New York Avenue, N.W. City: Washington, D.C. 7. State: Zip: 20001-4413 Deposit Account No.: 06-0916 8. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Richard V. Burgujian August 26, 2005 Reg. No. 31,744 Date

Total number of pages including cover sheet attachments and documents: 5

In consideration of value received, I, having a residence as stated below above my name, the sole inventor (if only one name is listed below) or a joint inventor (if plural inventors are listed below) of an invention described in an application for United States patent entitled:

METHOD OF MANUFACTURING A SEMICONDUCTOR DEVICE, AND A SEMICONDUCTOR SUBSTRATE

sell and assign to

- 1. KABUSHIKI KAISHA TOSHIBA, a Japanese corporation, having a business address at 1-1, Shibaura 1-chome, Minato-ku, Tokyo 105-8001, Japan; and
- 2. SEIKO EPSON CORPORATION, a Japanese corporation, having a business address at 4·1, Nishishinjuku 2·chome, Shinjuku·ku, Tokyo, Japan

its successors, assigns or nominees, hereinafter referred to as "Assignee", my entire right, title and interest in and to said invention as disclosed, shown and described in said United States patent application:

(check one)	[X]	executed concurrently herewith		
	[ ]	executed on	;	
	[ ]	Application No.	, filed	

and in and to all applications for patent and patents for invention including all divisions, reissues, continuations, substitutes and extensions thereof and all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property, including rights of priority, resulting from the filing of any of said applications; and I authorize and request any official whose duty is to issue patents, to issue any patent on said invention or resulting therefrom to said Assignee, and I agree that on request and without further consideration, but at the expense of said Assignee, I will communicate to said Assignee or its representatives all facts known to me respecting said invention and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing, continued prosecution, reissue, or other applications, make all rightful oaths and declarations, and generally do everything possible to aid said Assignee to obtain and enforce proper patent protection for said invention.

I hereby grant the following law firm the power to insert on this Assignment any further identification which may be necessary or desirable in order to comply with the Rules of the U.S. Patent and Trademark Office for recordation of this document.

Finnegan, Henderson, Farabow, Garrett & Dunner, L.L.P., 901 New York Avenue, NW Washington, D.C. 20001-4413

## ASSIGNMENT

APG038953-USA-A (04S1943-1)

Residence Address: Yokohama-shi, Japan Mailing Address: c/o Intellectual Property Division, To Minato-ku, Tokyo 105-8001, Japan Citizenship: Japan	oshiba Corporation, 1-1, Shibaura 1-chome,
Kunihiro Miyayahi Kunihiro Miyazaki	August 9, 2005 Date:
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Toshiki Nakajima	Date:

In consideration of value received, I, having a residence as stated below above my name, the sole inventor (if only one name is listed below) or a joint inventor (if plural inventors are listed below) of an invention described in an application for United States patent entitled:

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its successors, assigns or nominees, hereinafter referred to as "Assignee", my entire right, title and interest in and to said invention as disclosed, shown and described in said United States patent application:

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	[ ]	executed on	;
	[ ]	Application No.	, filed

and in and to all applications for patent and patents for invention including all divisions, reissues, continuations, substitutes and extensions thereof and all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property, including rights of priority, resulting from the filing of any of said applications; and I authorize and request any official whose duty is to issue patents, to issue any patent on said invention or resulting therefrom to said Assignee, and I agree that on request and without further consideration, but at the expense of said Assignee, I will communicate to said Assignee or its representatives all facts known to me respecting said invention and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing, continued prosecution, reissue, or other applications, make all rightful oaths and declarations, and generally do everything possible to aid said Assignee to obtain and enforce proper patent protection for said invention.

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Viroyuki Matsuo Hiroyuki Matsuo	Date: 01, 2005				
Hiroyuki Matsuo	Date: $\mathcal{O}$				
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**RECORDED: 08/26/2005**